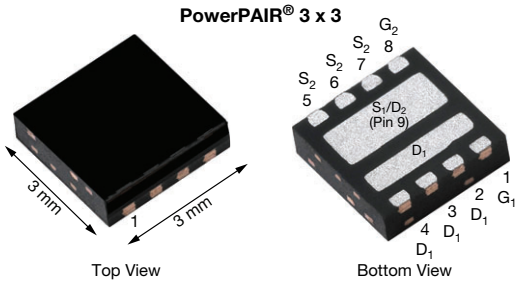
Dual N-Channel 25 V (D-S) MOSFETs



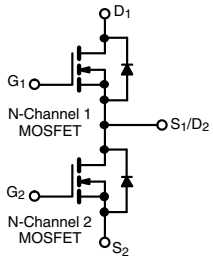
FEATURES

- TrenchFET® Gen IV power MOSFETs
- 100 % R_g and UIS tested
- Optimized Q_{gs}/Q_{gs} ratio improves switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- CPU core power
- Computer / server peripherals
- POL
- Synchronous buck converter
- Telecom DC/DC



PRODUCT SUMMARY

	CHANNEL-1	CHANNEL-2
V_{DS} (V)	25	25
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0150	0.0100
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0250	0.0150
Q_g typ. (nC)	2.1	3.5
I_D (A) [g]	25.3	30 [a]
Configuration	Dual	

ORDERING INFORMATION

Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ328DT-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	CHANNEL-1	CHANNEL-2	UNIT
Drain-source voltage		V_{DS}	25	25	V
Gate-source voltage		V_{GS}	+16, -12	+16, -12	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	25.3	30 [a]	A
	T_C = 70 °C		20.2	25.5	
	T_A = 25 °C		11.1 [b, c]	15 [b, c]	
	T_A = 70 °C		8.9 [b, c]	12 [b, c]	
Pulsed drain current (100 µs pulse width)		I_{DM}	40	50	
Continuous source drain diode current	T_C = 25 °C	I_S	12.6	13.5	
	T_A = 25 °C		2.4 [b, c]	3 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	7	11	
Single pulse avalanche energy		E_{AS}	2.5	6.1	mJ
Maximum power dissipation	T_C = 25 °C	P_D	15	16.2	W
	T_C = 70 °C		9.6	10.4	
	T_A = 25 °C		2.9 [b, c]	3.6 [b, c]	
	T_A = 70 °C		1.8 [b, c]	2.3 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150		°C
Soldering recommendations (peak temperature) [d]			260		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	CHANNEL-1		CHANNEL-2		UNIT
			TYP.	MAX.	TYP.	MAX.	
Maximum junction-to-ambient [b, f]	t ≤ 10 s	R_{thJA}	35	43	28	35	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	6.7	8.3	6.3	7.7	

Notes
a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR 3 x 3 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 80 °C/W for channel-1 and 69 °C/W for channel-2
g. T_C = 25 °C

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	Ch-1	25	-	-	V
		V_{GS} = 0 V, I_D = 250 µA	Ch-2	25	-	-	
V_{DS} Temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 250 µA	Ch-1	-	19	-	mV/°C
		I_D = 250 µA	Ch-2	-	18	-	
$V_{GS(th)}$ Temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	Ch-1	-	-4.1	-	
		I_D = 250 µA	Ch-2	-	-4.3	-	
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	Ch-1	1.1	-	2.5	V
		V_{DS} = V_{GS}, I_D = 250 µA	Ch-2	1.1	-	2.5	
Gate source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = +16 V, -12 V	Ch-1	-	-	± 100	nA
		V_{DS} = 0 V, V_{GS} = +16 V, -12 V	Ch-2	-	-	± 100	
Zero gate voltage drain current	I_{DSS}	V_{DS} = 25 V, V_{GS} = 0 V	Ch-1	-	-	1	µA
		V_{DS} = 25 V, V_{GS} = 0 V	Ch-2	-	-	1	
		V_{DS} = 25 V, V_{GS} = 0 V, T_J = 55 °C	Ch-1	-	-	5	
		V_{DS} = 25 V, V_{GS} = 0 V, T_J = 55 °C	Ch-2	-	-	5	
On-state drain current [b]	$I_{D(on)}$	$V_{DS} \geq$ 5 V, V_{GS} = 10 V	Ch-1	10	-	-	A
		$V_{DS} \geq$ 5 V, V_{GS} = 10 V	Ch-2	10	-	-	
Drain-source on-state resistance [b]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 5 A	Ch-1	-	0.0120	0.0150	Ω
		V_{GS} = 10 V, I_D = 5 A	Ch-2	-	0.0080	0.0100	
		V_{GS} = 4.5 V, I_D = 5 A	Ch-1	-	0.0175	0.0250	
		V_{GS} = 4.5 V, I_D = 5 A	Ch-2	-	0.0120	0.0150	
Forward transconductance [b]	g_{fs}	V_{DS} = 10 V, I_D = 10 A	Ch-1	-	25	-	S
		V_{DS} = 10 V, I_D = 10 A	Ch-2	-	42	-	
Dynamic [a]							
Input capacitance	C_{iss}	Channel-1 V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz Channel-2 V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	Ch-1	-	325	-	pF
			Ch-2	-	600	-	
Output capacitance	C_{oss}		Ch-1	-	115	-	
			Ch-2	-	230	-	
Reverse transfer capacitance	C_{rss}		Ch-1	-	20	-	
			Ch-2	-	31	-	
C_{rss}/C_{iss} ratio			Ch-1	-	0.060	0.120	
			Ch-2	-	0.052	0.110	
Total gate charge	Q_g	V_{DS} = 10 V, V_{GS} = 10 V, I_D = 5 A	Ch-1	-	4.6	6.9	nC
		V_{DS} = 10 V, V_{GS} = 10 V, I_D = 5 A	Ch-2	-	7.5	11.3	
		V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 5 A	Ch-1	-	2.1	3.2	
		V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 5 A	Ch-2	-	3.5	5.3	
Gate-source charge	Q_{gs}	Channel-1 V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 5 A Channel-2 V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 5 A	Ch-1	-	0.95	-	
			Ch-2	-	1.63	-	
Gate-drain charge	Q_{gd}		Ch-1	-	0.37	-	
			Ch-2	-	0.54	-	
Output charge	Q_{oss}	V_{DS} = 10 V, V_{GS} = 0 V	Ch-1	-	1.7	-	
			Ch-2	-	3.4	-	
Gate resistance	R_g	f = 1 MHz	Ch-1	0.28	1.4	2.8	Ω
			Ch-2	0.18	0.9	1.8	

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNIT**
Dynamic [a]							
Turn-on delay time	$t_{d(on)}$	Channel-1 V_{DD} = 10 V, R_L = 2 Ω $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω Channel-2 V_{DD} = 10 V, R_L = 2 Ω $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω	Ch-1	-	7	15	ns
			Ch-2	-	8	16	
Rise time	t_r		Ch-1	-	11	25	
			Ch-2	-	5	10	
Turn-off delay time	$t_{d(off)}$		Ch-1	-	12	25	
			Ch-2	-	15	30	
Fall time	t_f		Ch-1	-	5	10	
			Ch-2	-	5	10	
Turn-on delay time	$t_{d(on)}$	Channel-1 V_{DD} = 10 V, R_L = 2 Ω $I_D \cong$ 5 A, V_{GEN} = 4.5 V, R_g = 1 Ω Channel-2 V_{DD} = 10 V, R_L = 2 Ω $I_D \cong$ 5 A, V_{GEN} = 4.5 V, R_g = 1 Ω	Ch-1	-	13	30	
			Ch-2	-	15	30	
Rise time	t_r		Ch-1	-	66	75	
			Ch-2	-	61	120	
Turn-off delay time	$t_{d(off)}$		Ch-1	-	8	20	
			Ch-2	-	10	20	
Fall time	t_f		Ch-1	-	5	10	
			Ch-2	-	5	10	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I_S	T_C = 25 °C	Ch-1	-	-	12.6	A
			Ch-2	-	-	13.5	
Pulse diode forward current (t = 100 µs)	I_{SM}		Ch-1	-	-	40	
			Ch-2	-	-	50	
Body diode voltage	V_{SD}	I_S = 5 A, V_{GS} = 0 V	Ch-1	-	0.82	1.2	V
		I_S = 5 A, V_{GS} = 0 V	Ch-2	-	0.83	1.2	
Body diode reverse recovery time	t_{rr}	Channel-1 I_F = 5 A, di/dt = 100 A/µs, T_J = 25 °C Channel-2 I_F = 5 A, di/dt = 100 A/µs, T_J = 25 °C	Ch-1	-	16	35	ns
			Ch-2	-	21	40	
Body diode reverse recovery charge	Q_{rr}		Ch-1	-	10	20	nC
			Ch-2	-	11	20	
Reverse recovery fall time	t_a		Ch-1	-	10	-	ns
			Ch-2	-	11	-	
Reverse recovery rise time	t_b		Ch-1	-	6	-	
			Ch-2	-	10	-	

Notes

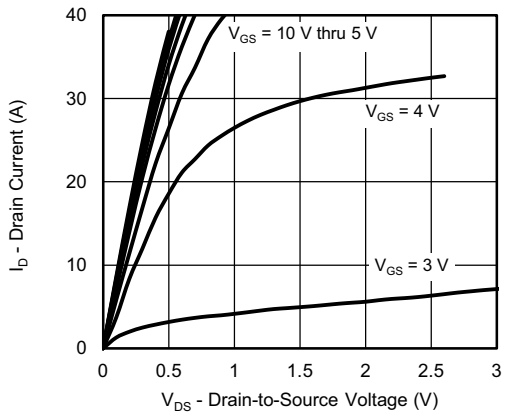
a. Guaranteed by design, not subject to production testing

b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %

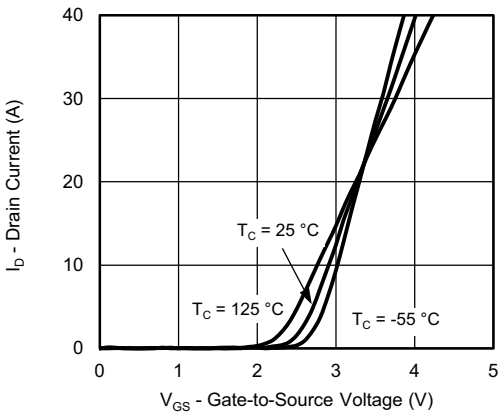
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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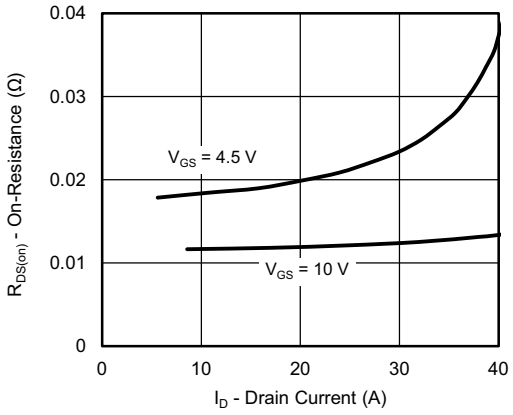
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



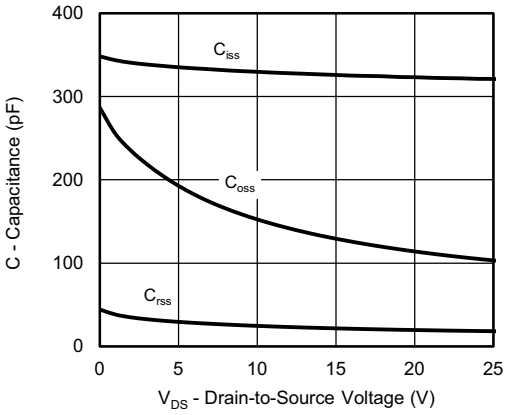
Output Characteristics



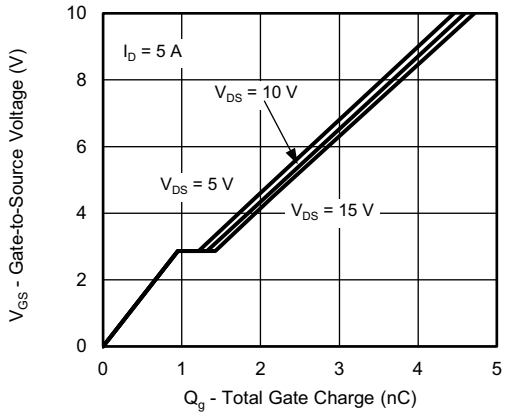
Transfer Characteristics



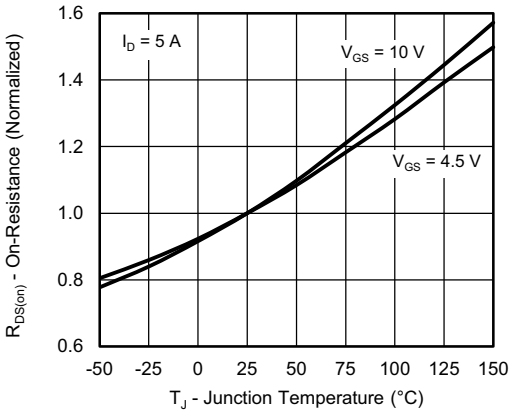
On-Resistance vs. Drain Current



Capacitance



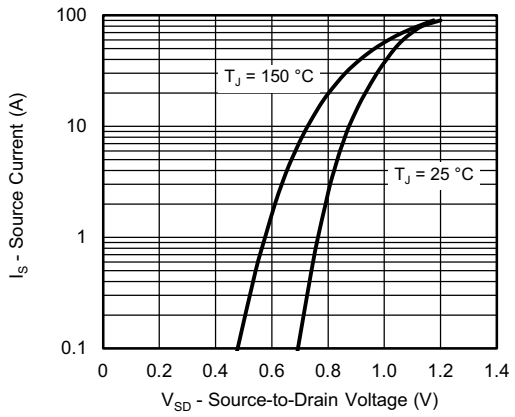
Gate Charge



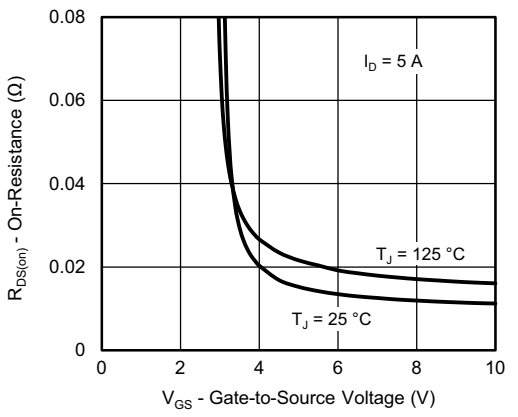
On-Resistance vs. Junction Temperature

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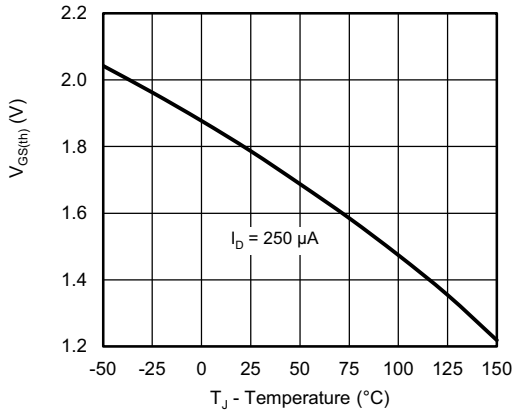
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



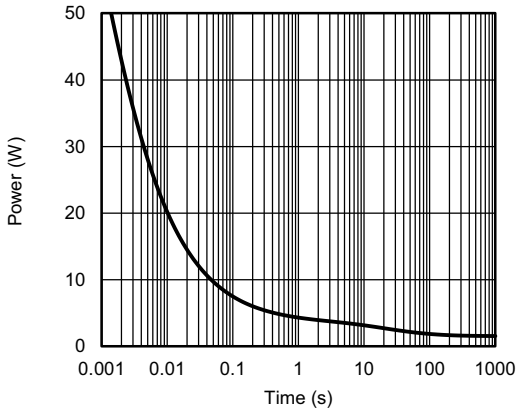
Source-Drain Diode Forward Voltage



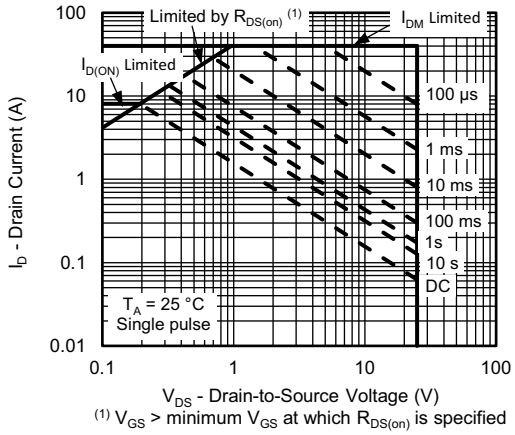
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



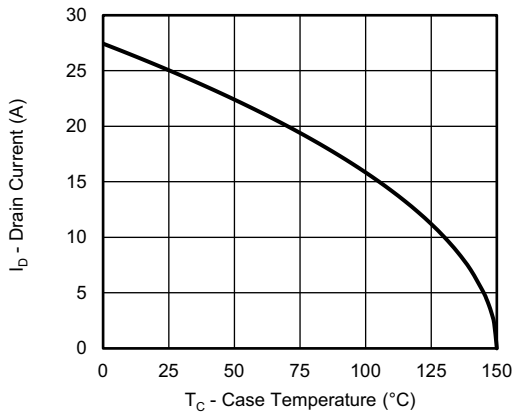
Single Pulse Power, Junction-to-Ambient



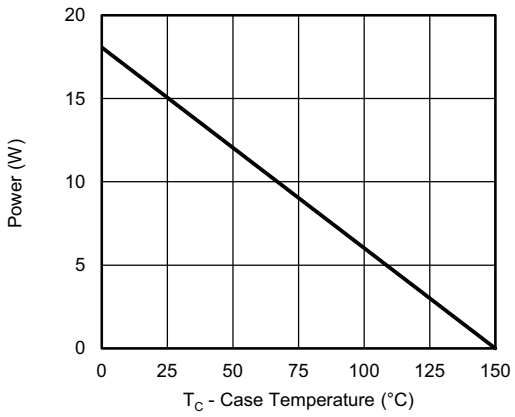
Safe Operating Area, Junction-to-Ambient

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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]



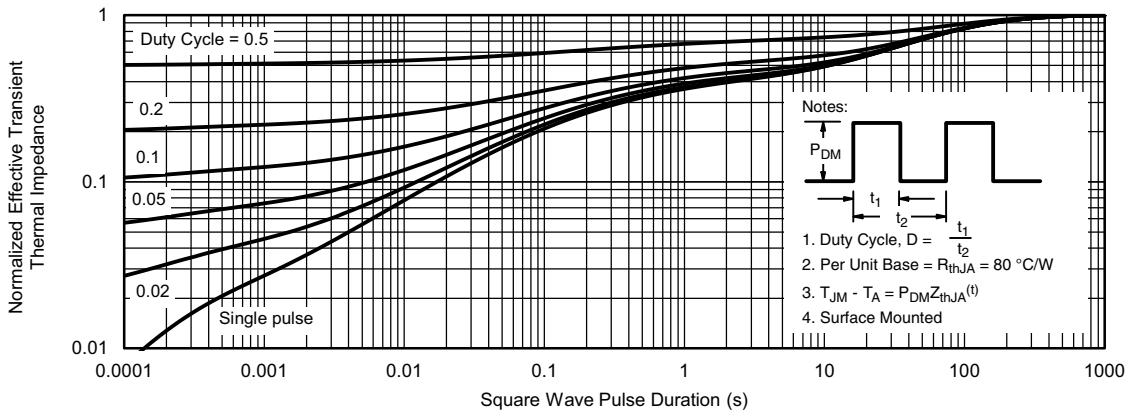
Power, Junction-to-Case

Note

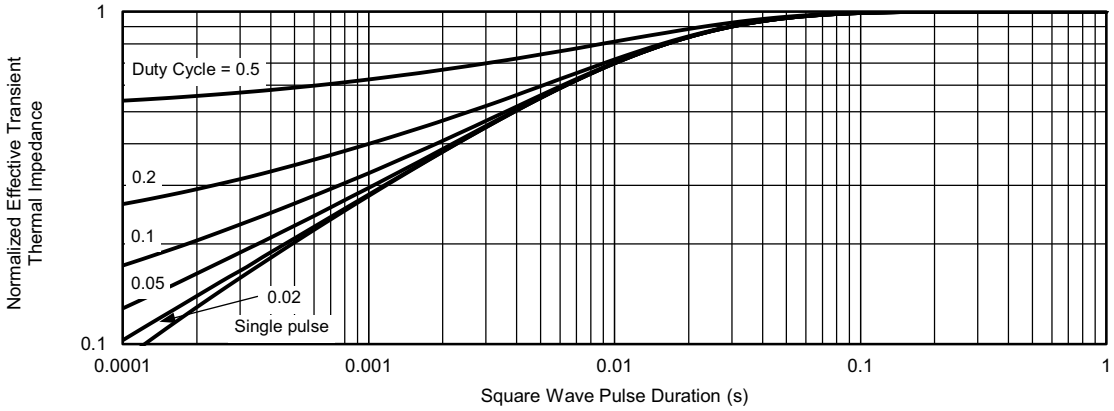
a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



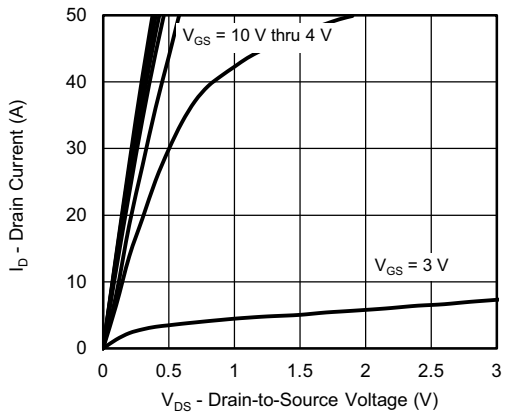
Normalized Thermal Transient Impedance, Junction-to-Ambient



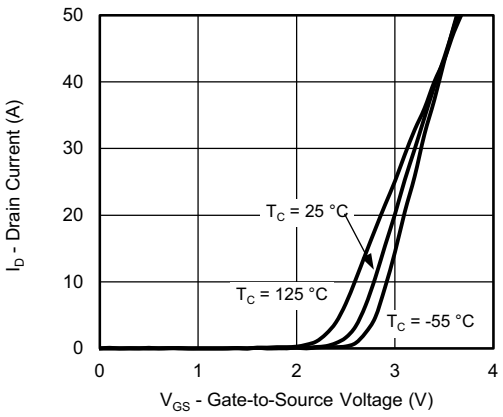
Normalized Thermal Transient Impedance, Junction-to-Case

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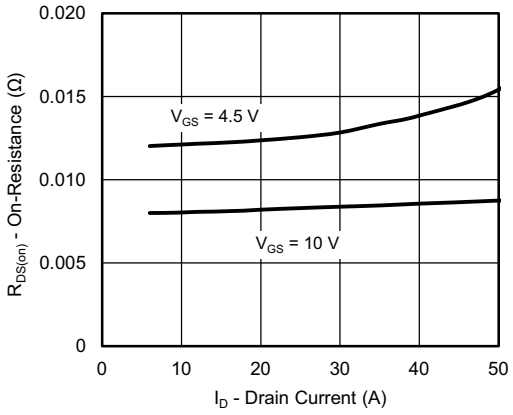
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



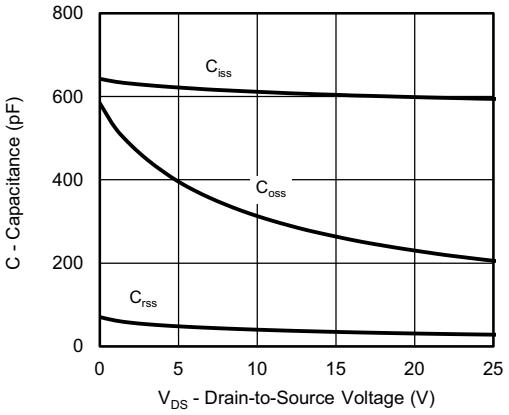
Output Characteristics



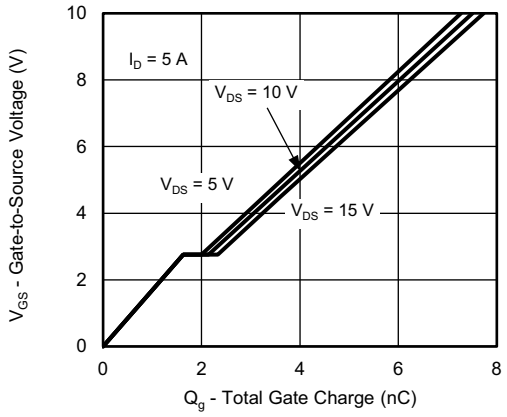
Transfer Characteristics



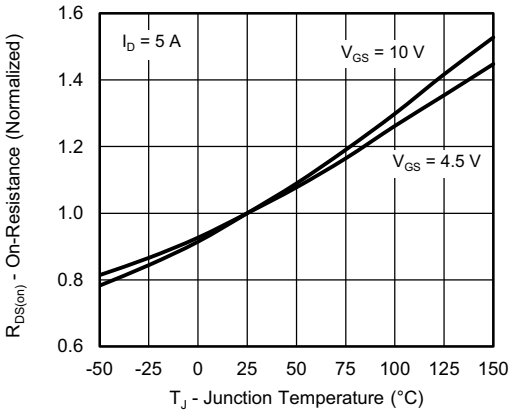
On-Resistance vs. Drain Current



Capacitance



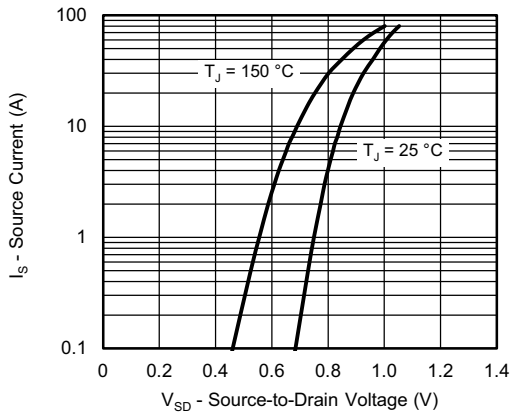
Gate Charge



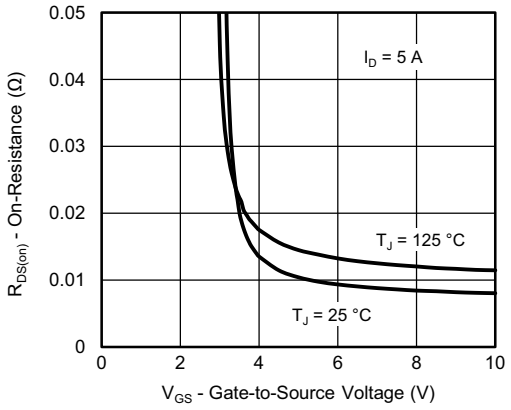
On-Resistance vs. Junction Temperature

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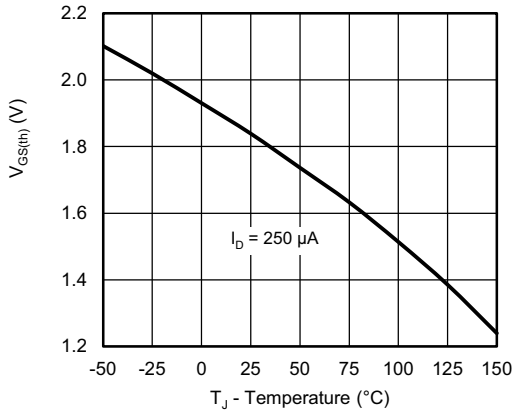
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



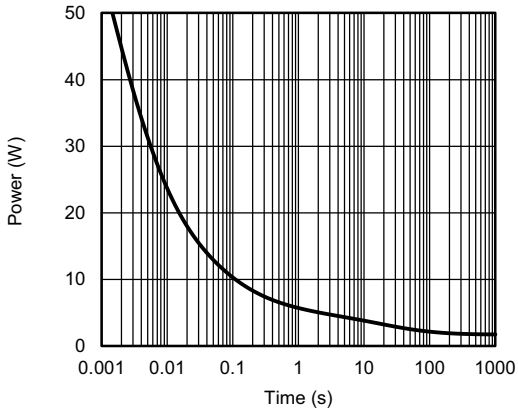
Source-Drain Diode Forward Voltage



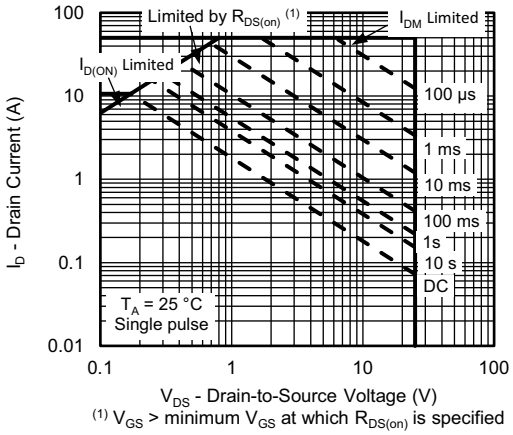
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



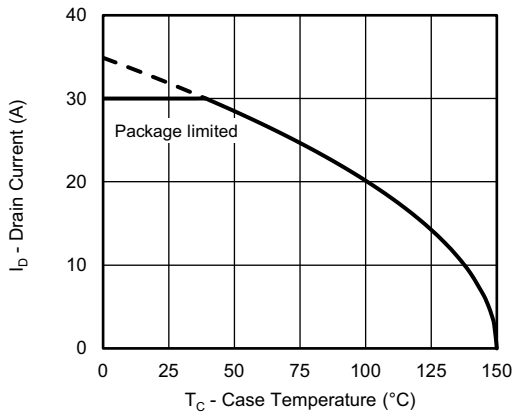
Single Pulse Power, Junction-to-Ambient



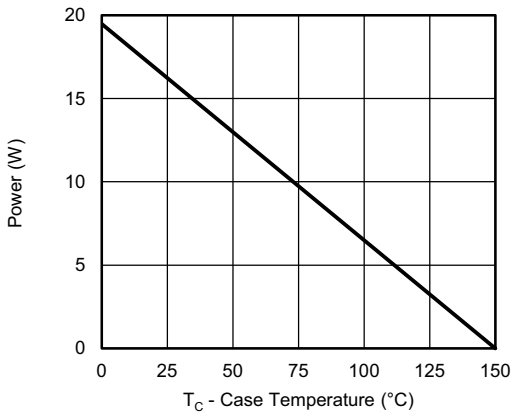
Safe Operating Area, Junction-to-Ambient

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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]



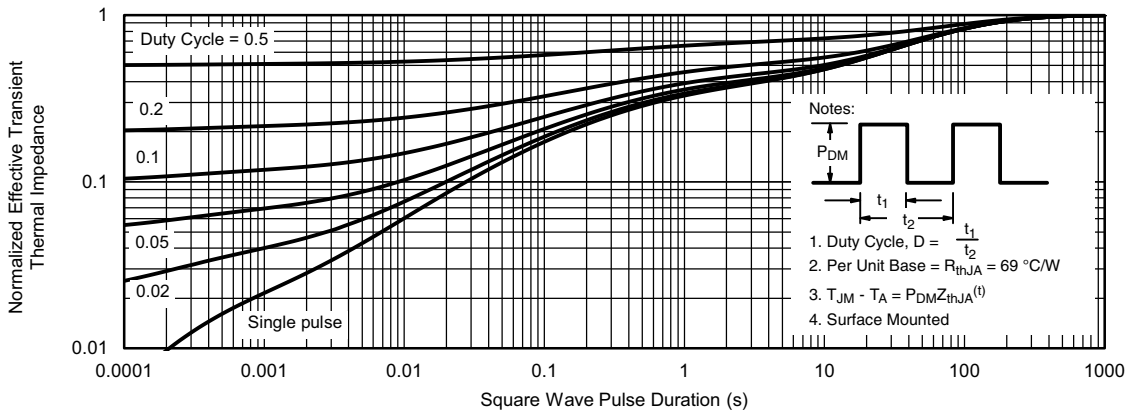
Power, Junction-to-Case

Note

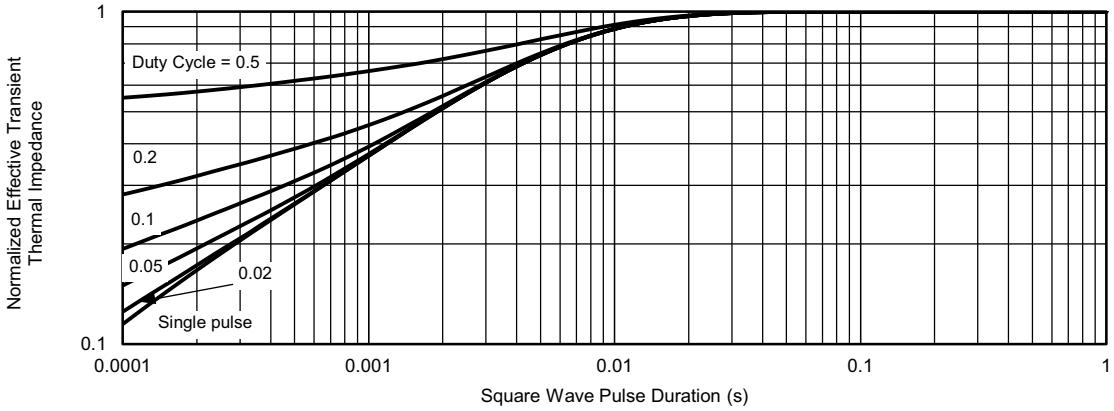
a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

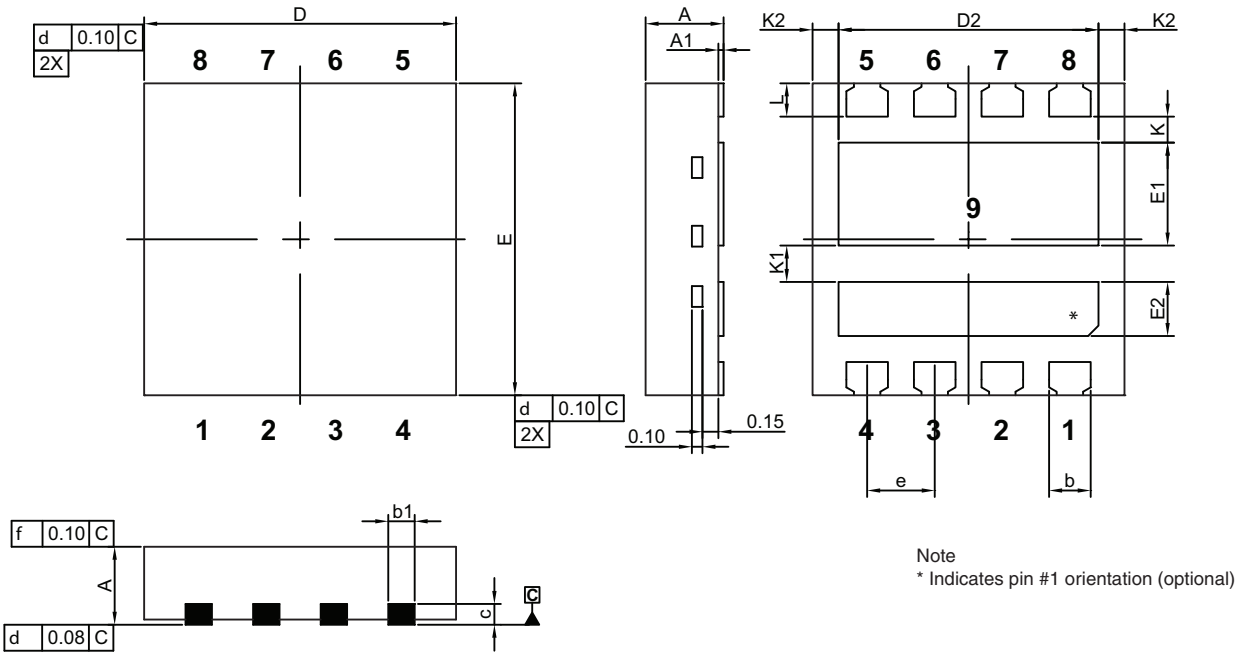


Normalized Thermal Transient Impedance, Junction-to-Case

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PowerPAIR® 3 x 3 Case Outline

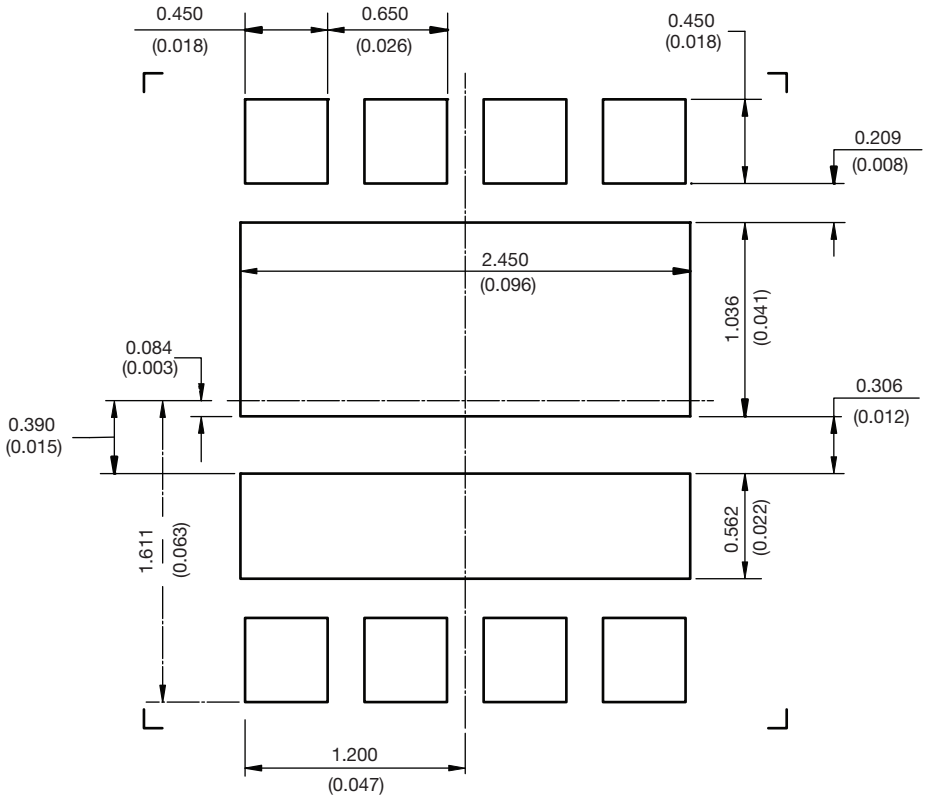


Note
* Indicates pin #1 orientation (optional)

DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00		0.05	0.000		0.002
b	0.35	0.40	0.45	0.014	0.016	0.018
b1	0.20	0.25	0.38	0.008	0.010	0.015
C	0.18	0.20	0.23	0.007	0.008	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
D2	2.35	2.40	2.45	0.093	0.094	0.096
E	2.90	3.00	3.10	0.114	0.118	0.122
E1	0.94	0.99	1.04	0.037	0.039	0.041
E2	0.47	0.52	0.57	0.019	0.020	0.022
e	0.65 BSC			0.026 BSC		
K	0.25 typ.			0.010 typ.		
K1	0.35 typ.			0.014 typ.		
K2	0.30 typ.			0.012 typ.		
L	0.27	0.32	0.37	0.011	0.013	0.015
ECN: T12-0347-Rev. C, 18-Jun-12 DWG: 5998						

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RECOMMENDED MINIMUM PAD FOR PowerPAIR® 3 x 3



Recommended PAD for PowerPAIR 3 x 3

Dimensions in millimeters (inches)

Keep-Out 3.5 mm x 3.5 mm for non terminating traces

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